SDLS036 - DECEMBER 1983 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

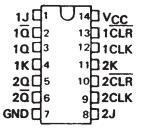
#### description

The '107 contain two independent J-K flip-flops with individual J-K, clock, and direct clear inputs. The '107 is a positive pulse-triggered flip-flop. The J-K input data is loaded into the master while the clock is high and transferred to the slave and the outputs on the high-to-low clock transistion. For these devices the J and K inputs must be stable while the clock is high.

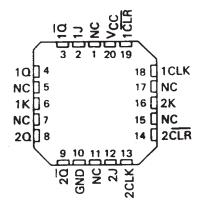
The 'LS107A contain two independent negative-edge-triggered flip-flops. The J and K inputs must be stable prior to the high-to-low clock transition for predictable operation. When the clear is low, it overrides the clock and data inputs forcing the Q output low and the  $\overline{\mathbf{Q}}$  output high.

The SN54107 and the SN54LS107A are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125 $\,^{\circ}\text{C}$ . The SN74107 and the SN74LS107A are characterized for operation from 0 $\,^{\circ}\text{C}$  to 70 $\,^{\circ}\text{C}$ .

SN54107, SN54LS107A . . . J PACKAGE SN74107 . . . N PACKAGE SN74LS107A . . . D OR N PACKAGE (TOP VIEW)



SN54LS107A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

'107
FUNCTION TABLE

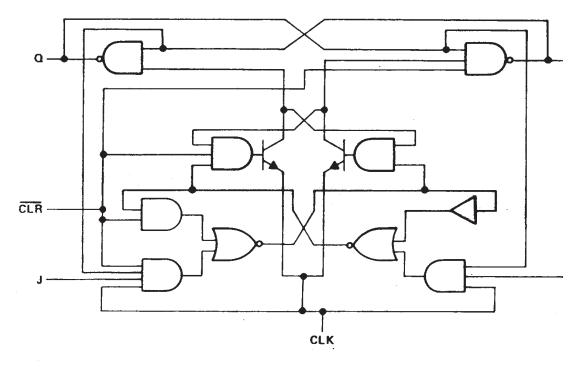
	INPU	TS		OUT	UTS
CLR	CLK	J	К	Q	ā
L	×	Х	Х	L	Н
Н	ır	L	L	$\alpha_0$	$\overline{a}_0$
Н	T	Н	L	н	L
Н	, T	L	н	L	Н
Н	л	Н	н	TOG	GLE

'LS 107A FUNCTION TABLE

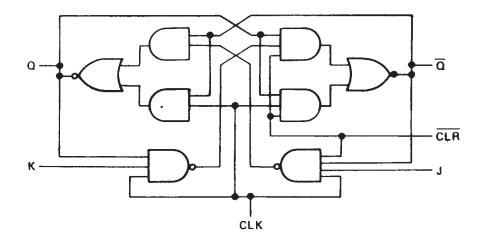
	INPU	OUTPUTS				
CLR	CLK	J	К	α	₫	
L	×	Х	Х	L	Η	
н	1	L	L	$\sigma_0$	$\bar{a}_0$	
н	4	н	L	н	L	
н	1	L	Н	L	н	
н⊦	4	H.	н	TOGGLE		
н	н	X	×	α <sub>0</sub>	$\overline{a}_0$	



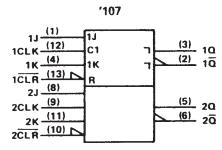
## logic diagrams (positive logic)

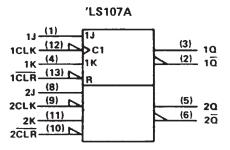


'LS107A



## logic symbols†





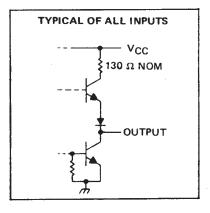
 $^\dagger$ These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N packages.

#### schematic of inputs and outputs

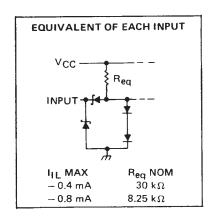
INPUT

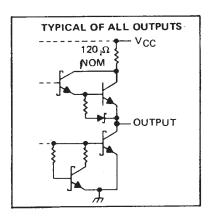
Include A Head NOM





#### 'LS107A





# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, Vcc (see Note 1)		7 V
Input voltage: '107		5.5 V
'I \$107Δ		7 V
Operating free-air temperature range: SN		55°C to 125°C
Sh	174'	0°C to 70°C
Change tomporature range		65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



#### recommended operating conditions

				SN54107			SN74107		
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage		2			2			٧
VIL	Low-level input voltage				0.8			8.0	٧
ЮН	High-level output current				- 0.4			- 0.4	mA
IOL	Low-level output current				16			16	mA
		CLK high	20			20			
tw	Pulse duration	CLK low	47			47			ns
		CLR low	25			25			
t <sub>su</sub>	Input setup time before CLK1		0			0			ns
th	Input hold time-data after CLK1		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAG.	RAMETER	TEST CONDITIONS†			SN54107			SN74107				
FAR	AMETER		TEST CONDITION	ONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
$v_{iK}$		V <sub>CC</sub> = MIN,	I <sub>1</sub> = - 12 mA				- 1.5			<b>– 1.5</b>	V	
V <sub>OH</sub>		V <sub>CC</sub> = MIN,		V <sub>IL</sub> = 0.8 V,	2.4	3.4		2.4	3.4		V	
VOL		V <sub>CC</sub> = MIN, I <sub>OL</sub> = 16 mA	V <sub>IH</sub> = 2 V,	V <sub>1</sub> L = 0.8 V,		0.2	0.4		0.2	0.4	٧	
l <sub>l</sub>		V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1			1	mA	
1	J or K	VMAY	V1 = 2.4 V				40			40		
ΊΗ	All other	V <sub>CC</sub> = MAX,	V   = 2.4 V				80			80	μΑ	
1	J or K	VMAY	V =0.4 V				- 1.6			- 1.6		
ΊL	All other	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				- 3.2			- 3.2	mA	
los §		V <sub>CC</sub> = MAX			- 20		- 57	- 18		- 57	mA	
lcc1		V <sub>CC</sub> = MAX,	See Note 2			10	20		10	20	mA	

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open, I<sub>CC</sub> is measured with the Q and Q outputs high in turn. At the time of measurement, the clock input is grounded.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub>				15	20		MHz
<sup>t</sup> PLH	CLR	ā			16	25	ns
<sup>t</sup> PHL	CLA	Q	$R_{\perp} = 400 \Omega$ , $C_{\perp} = 15 pF$		25	40	ns
<sup>t</sup> PLH	CLK	Q or $\overline{\Omega}$			16	25	ns
<sup>t</sup> PHL	CLK	d or d			25	40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>ddagger}$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 ° C.

<sup>&</sup>lt;sup>§</sup>Not more than one output should be shorted at a time.

<sup>¶</sup>Average per flip-flop.

#### recommended operating conditions

			S	SN54LS107A			SN74LS107A		
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
ViH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			8.0	V
ПОН	High-level output current			-	- 0.4			- 0.4	mA
†OL	Low-level output current				4			8	mA
fclock	Clock frequency		0		30	0		30	MHz
	Dulan dunadan	CLK high	20			20			
tw	Pulse duration	CLR low	25		;	25		,	ns
	0	data high or low	20			20			
<sup>t</sup> su	Setup time before CLK #	CLR inactive	25			25			ns
th	Hold time-data after CLK↓		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			FOT COMPLETION	uct	18	154LS10	7A	SN	UNIT			
PA	RAMETER	TEST CONDITIONS <sup>†</sup>			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNII	
VIK		V <sub>CC</sub> = MIN,	I <sub>I</sub> = - 18 mA				- 1.5			<b>– 1.5</b>	V	
Vон		V <sub>CC</sub> = MIN, I <sub>OH</sub> = - 0.4 mA	V <sub>IH</sub> = 2 V,	VIL = MAX,	2.5	3.4		2.7	3.4		٧	
V-		V <sub>CC</sub> = MIN, I <sub>OL</sub> = 4 mA	VIL = MAX,	V <sub>IH</sub> = 2 V,		0.25	0.4		0.25	0.4	V	
VOL		V <sub>CC</sub> = MIN, I <sub>OL</sub> = 8 mA	VIL = MAX,	V <sub>IH</sub> = 2 V,					0.35	0.5	V	
	J or K						0.1			0.1		
4	CLR	V <sub>CC</sub> = MAX,	V1 = 7 V				0.3			0.3	mA	
	CLK						0.4			0.4		
	J or K						20			20		
ΉН	CLR	V <sub>CC</sub> = MAX,	V; = 2.7 V		60		60	60		60	μΑ	
	CLK		-		80			80				
	J or K						- 0.4			- 0.4	mA	
HL	CLR or CLK	V <sub>CC</sub> = MAX,	V   = U.4 V				- 0.8			0.8		
los§		V <sub>CC</sub> = MAX,	See Note 4		- 20		- 100	- 20		- 100	mA	
Icc (	Total)	V <sub>CC</sub> = MAX,	See Note 2			4	6		4	6	mA	

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST COM	TEST CONDITIONS				UNIT
fmax			· · · · · · · · · · · · · · · · · · ·		30	45		MHz
tPLH	<del></del>	^ =	$R_L = 2 k\Omega$ ,	C <sub>L</sub> = 15 pF		15	20	ns
tPHL	CLR or CLK	Q or Q				15	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>\</sup>ddagger$  All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: With all outputs open,  $I_{CC}$  is measured with the Q and  $\overline{Q}$ , outputs high in turn. At the time of measurement, the clock input is grounded.

NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V<sub>O</sub> = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

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